Declaration and Power of Attorney For Patent Application English Language Declaration

	Englis	h Langua	ge Declaration		
As a below named inv	entor, I hereby de	eclare that:			
My residence, post office address and citizenship are as stated below next to my name,					
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled SEMICONDUCTOR DEVICE AND METHOD FOR PRODUCING THE SAME, the specification of which is attached hereto unless the following box is checked: was filed on May 5, 2000 as United States Application Number or PCT International Application Number09/565,937 and was amended on (if applicable). I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.					
I acknowledge the duty 1.56.	y to disclose infor	mation which	is material to patentabil	lity as defined in 37 CFR	§
application(s) for pater designated at least or below by checking the	nt or inventor's ce ne country other he box, any fore on having a filing d	ertificate, or § than the Unit eign applicati	365(a) of any PCT Inte ted States, listed belov ion for patent or inve	§ 365(b) of any foreignational application while wand have also identificate, or Powerlich priority is claimed. Priority Not Claimed	ch ed CT
(Number)	(Country)	•	(Day/Month/Year Filed)		
(Number)	(Country)		(Day/Month/Year Filed)		
I hereby claim the be listed below.	nefit under 35 U.	.S.C. § 119(e	e) of any United States	s provisional application((s)
(Application Number)	(Filing Date)				
(Application Number)	(Filing Date)				
PCT International app matter of each of the International application acknowledge the duty	lication designatir claims of this apon in the manne to disclose inform	ng the United pplication is r er provided t nation which is	States, listed below a not disclosed in the propy the first paragraph s material to patentabili	ication(s), or 365(c) of an and, insofar as the subjection United States or PC an of 35 U.S.C. § 112, aty as defined in 37 CFR and the national or PC	ct CT I §

international filing date of this application:

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(Application Number)		(Filing Date)	(Status - pate	ented, pending, abandone		
(Application Number)		(Filing Date)	(Status - pate	(Status - patented, pending, abandoned)		
POWER OF AT agent(s) to prose connected therev	ecute this appl	a named inventor, ication and transac	I hereby appoit all business in	int the following at n the Patent and T	torney(s) and/or rademark Office	
Paul F. Prestia Allan Ratner Andrew L. Ney Kenneth N. Nigon Kevin R. Casey Benjamin E. Leace James C. Simmons	Reg. No. 23,031 Reg. No. 19,717 Reg. No. 20,300 Reg. No. 31,549 Reg. No. 32,117 Reg. No. 33,412 Rég. No. 24,842	Lawrence E. Ashery Christopher R. Lewis Robert L. Andersen Daniel N. Calder Louis W. Beardell, Jr. Jacques L. Etkowicz, Eric A. Dichter	Reg. No. 34,515 Reg. No. 36,201 Reg. No. 25,771 Reg. No. 27,424 Reg. No. 40,506 Reg. No. 41,738 Reg. No. 41,708	Mark J. Marcelli Joshua L. Cohen Jack J. Jankovitz Jonathan H. Spadt Christopher I. Halliday	Reg. No. 36,593 Reg. No. 38,040 Reg. No. 42,690 Reg. No. 45,122 Reg. No. 42,621	
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statements made were made with t by fine or impriso such willful false	on information the knowledge onment, or bot statements ma	atements made he and belief are belief that willful false h, under Section 10 y jeopardize the validation for the belief the that was for the same f	ieved to be true statements and 101 of Title 18 of dity of the applic	; and further that the the like so made of the United States	nese statements are punishable Code and that	
Full name of sole or fir Inventor's signature _ Residence <u>Kyoto, Jap</u> Citizenship <u>Japanese</u>	Toshik	agu Onishi	ikazu ONISHI	Date July	28, 2000	
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Citizenship <u>Japanese</u> Post Office Address <u>3</u>	<u> </u>	deto Adachi 67-0044 Japan		Date July 2	28, 2000	
X Additional inver	ntors are being nam	ned on separately number	ed sheets attached t	nereto.		

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	? -
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Fifth inventor's signature	Date
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Citizenship	
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Full name of sixth joint inventor, if any (given name, family name)	
Sixth inventor's signature	Date
Residence	
Citizenship	
Post Office Address	
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Full name of seventh joint inventor, if any (given name, family name)	
Seventh inventor's signature	Date
Residence	
Citizenship	
Post Office Address	
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